NCE30ND09S

NCE N-Channel Enhancement Mode Power MOSFET

Description

The NCE30ND09S uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

General Features

V_{DS} =30V,I_D =9A

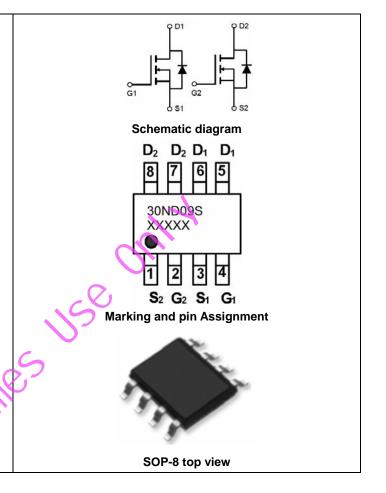
 $R_{DS(ON)}$ < 12m Ω @ V_{GS} =10V

 $R_{DS(ON)}$ < 17m Ω @ V_{GS} =4.5V

- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current

Application

- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply



Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
30ND09S	NCE30ND09S	SOP-8	Ø330mm	12mm	4000 units

Absolute Maximum Ratings (T_A=25 ℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V _{DS}	30	V
Gate-Source Voltage	V _G s	±20	V
Drain Current-Continuous	I _D	9	А
Drain Current-Continuous(T _C =100°C)	I _D (100℃)	6.4	Α
Pulsed Drain Current	I _{DM}	40	Α
Maximum Power Dissipation	P _D	2	W
Operating Junction and Storage Temperature Range	T_{J} , T_{STG}	-55 To 150	$^{\circ}\!\mathbb{C}$

Thermal Characteristic

Parameter	Symbol	Тур	Max	Unit
Thermal Resistance, Junction-to-Ambient (Note 2)	$R_{\theta JA}$	62.5	85	°C/W

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Electrical Characteristics (T_c=25 ℃ unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics			•			
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250μA	30	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =30V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)			•			
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	1.0	1.6	2.2	V
Drain-Source On-State Resistance	Б	V _{GS} =10V, I _D =6A	-	10.3	12.0	mΩ
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =4.5V, I _D =4A	-	13.9	17.0	mΩ
Forward Transconductance	g FS	V _{DS} =5V,I _D =6A	26	-	-	S
Dynamic Characteristics (Note4)		•	1			
Input Capacitance	C _{Iss}	V _{DS} =15V,V _{GS} =0V,	-	1210	-	PF
Output Capacitance	Coss	F=1.0MHz	-	160	-	PF
Reverse Transfer Capacitance	C _{rss}	F=1.UMHZ	-	105	-	PF
Switching Characteristics (Note 4)		160				
Turn-on Delay Time	t _{d(on)}		-	5	-	nS
Turn-on Rise Time	t _r	V_{DD} =15V, R_L =0.75 Ω	-	12	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =10V,R _G =3 Ω	-	19	-	nS
Turn-Off Fall Time	t _f		-	6	-	nS
Total Gate Charge	Q_g	V 45VI 6A	-	17.5		nC
Gate-Source Charge	Q_{gs}	V_{DS} =15V, I_D =6A, V_{GS} =10V	-	3		nC
Gate-Drain Charge	Q_{gd}	V _{GS} =10V	-	4.1		nC
Drain-Source Diode Characteristics	<u>Or</u>		•			
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =6A	-		1.2	V
Diode Forward Current (Note 2)	Is		-	-	9	Α
Reverse Recovery Time	t _{rr}	TJ = 25°C, IF =6A	-	19	-	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/μs ^(Note3)	-	10	-	nC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is neglig	gible (turi	n-on is do	ominated b	y LS+LD)

Notes:

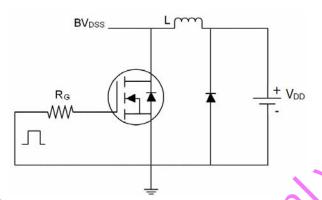
- 1. Repetitive Rating. Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- 3. Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- 4. Guaranteed by design, not subject to production

Pb Free Product

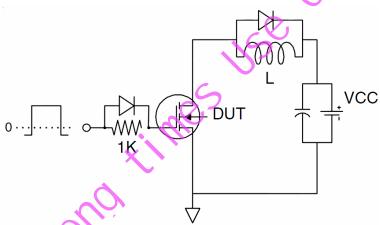
NCE30ND09S

Test circuit

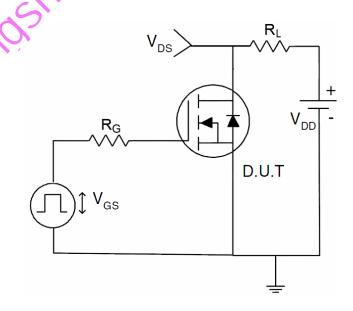
1) E_{AS} test Circuits



2) Gate charge test Circuit:



3) Switch Time Test Circuit:





Typical Electrical and Thermal Characteristics (Curves)

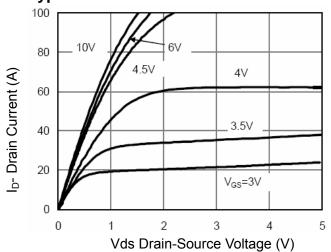


Figure 1 Output Characteristics

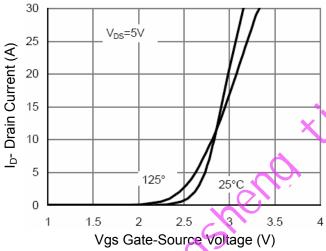


Figure 2 Transfer Characteristics

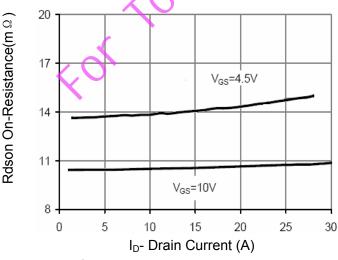


Figure 3 Rdson- Drain Current

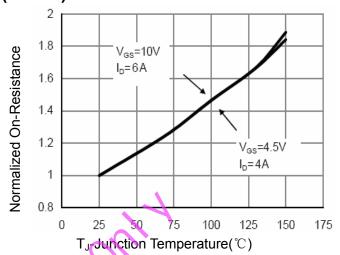


Figure 4 Rdson-Junction Temperature

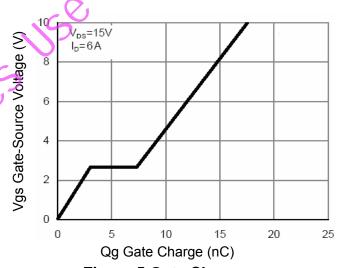


Figure 5 Gate Charge

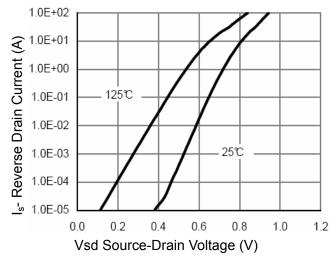
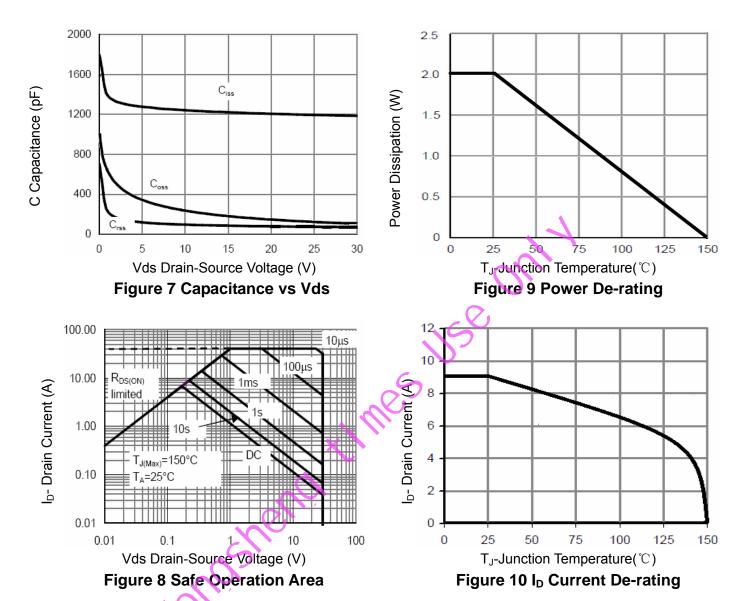


Figure 6 Source- Drain Diode Forward





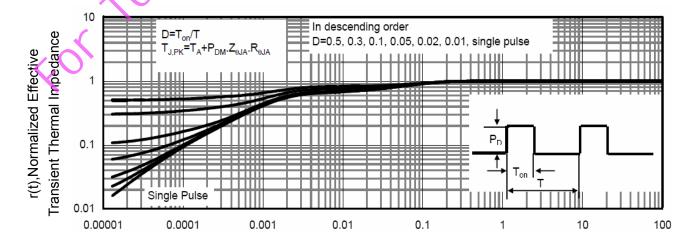


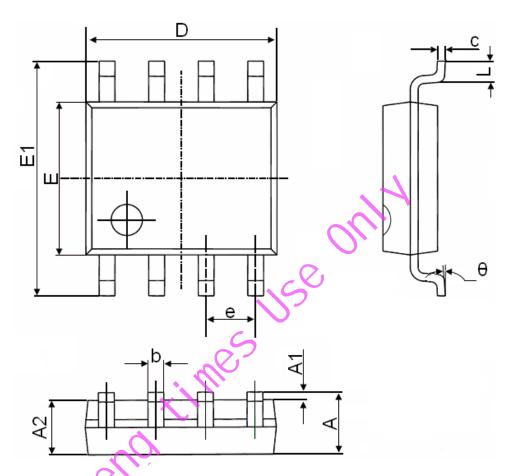
Figure 11 Normalized Maximum Transient Thermal Impedance

Square Wave Pluse Duration(sec)





SOP-8 Package Information



Cremb al	Dimensions In Millimeters		Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
Α	1,350	1.750	0.053	0.069	
A1	0.100	0.250	0.004	0.010	
A2	1.350	1.550	0.053	0.061	
b	0.330	0.510	0.013	0.020	
С	0.170	0.250	0.006	0.010	
D	4.700	5.100	0.185	0.200	
E	3.800	4.000	0.150	0.157	
E1	5.800	6.200	0.228	0.244	
е	1.270	D(BSC)	0.050(BSC)		
L	0.400	1.270	0.016	0.050	
θ	0°	8°	0°	8°	



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